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DATE MAILED: 07/14/2006

CONFIRMATION NO. FIRST NAMED INVENTOR ATTORNEY DOCKET NO. FILING DATE APPLICATION NO. FIS920040258US1 5699 Kevin S. Petrarca 09/30/2004 10/711,700 **EXAMINER** 07/14/2006 32074 7590 NGUYEN, TRAM HOANG INTERNATIONAL BUSINESS MACHINES CORPORATION DEPT. 18G ART UNIT PAPER NUMBER BLDG. 300-482 2818 2070 ROUTE 52 HOPEWELL JUNCTION, NY 12533

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Applicant(s)				
	PETRARCA ET A	L.			
	Art Unit				
	2818				
t with the correspondence address					
3 MONTH(S) OR THIRTY (30) DAYS, JNICATION. ay a reply be timely filed					
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C. § 119(a))-(d) or (f).				
in Application No een received in this National Stage					

	Application No.	Applicant(s)		
	10/711,700	PETRARCA ET AL.		
Office Action Summary	Examiner	Art Unit		
	Tram H. Nguyen	2818		
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply				
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).				
Status				
 Responsive to communication(s) filed on <u>17 April 2006</u>. This action is FINAL. 2b) This action is non-final. Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i>, 1935 C.D. 11, 453 O.G. 213. 				
Disposition of Claims				
 4) Claim(s) 1-20 is/are pending in the application. 4a) Of the above claim(s) 6-12 and 16-20 is/are withdrawn from consideration. 5) Claim(s) is/are allowed. 6) Claim(s) 1-5 and 13-15 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or election requirement. 				
Application Papers				
9) The specification is objected to by the Examiner. 10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner. Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a). Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.				
Priority under 35 U.S.C. § 119				
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 				
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 04/17/2006.	4) Interview Summary Paper No(s)/Mail D: 5) Notice of Informal P 6) Other:			

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DETAILED ACTION

New Grounds of Rejection

Claim Rejections - 35 U.S.C. § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).
- 3. Claims 1-5 and 13-15 are rejected under 35 U.S.C. 103 (a) as being unpatentable over Andricacos et al. (U.S. Patent No. 6,709,562 B1) (hereinafter Andricacos).

Regarding **claim 1**, Andricacos discloses a copper interconnect (fig. 6) comprising: an impure copper seed layer (reference numeral 5) derived from an impure copper source with a content of impurities that is deposited on a barrier layer (reference

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numeral 4), said barrier layer (4) prevents substantial diffusion of copper through to an underlying insulating layer (reference numeral 1); an impure copper (reference numeral 6) derived from an impure copper source with a content of impurities that fills an opening in said underlying insulating layer (6) that is deposited on said impure copper seed layer (5). Although, Andricacos does not explicitly teach the material composition of said seed layer is substantially the same as material composition of said impure copper fill, it would have been obvious to one having ordinary skill in the art at the time the invention was made to use the same material composition for both the impure copper seed layer and the impure copper fill, since it is going to lower the cost of making the product.

Regarding **claim 2**, Andricacos discloses all the limitations of the claimed invention for the same reasons are set-forth above except for the copper source of said impure copper seed layer is equivalent to said copper source of said impure copper. However, it would have been obvious to one having ordinary skill in the art at the time the invention was made to use the same material composition for both the impure copper seed layer and the impure copper fill, since it is going to lower the cost of making the product.

Regarding to **claim 3**, Andricacos discloses all the limitations of the claimed invention; on another hand, the Applicant admits the copper in the impure copper seed layer and the electroplated copper are both derived from a source with an impurity content of not more than 1.2 % by weight and not less than or equal to 0.001% by

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weight are general well-known impure copper sources (present Invention's specification: pg. 5, par. 20, lines 4-9).

Regarding claim 4, Andricacos discloses all the limitations of the claimed invention for the same reasons are set-forth above except for explicitly teaching the impure copper in said impure copper seed layer is substantially equivalent to said impure copper. However, it would have been obvious to one having ordinary skill in the art at the time the invention was made to use the same material composition for both the impure copper seed layer and the impure copper fill, since it is going to lower the cost of making the product.

Regarding claim 5, Andricacos discloses all the limitations of the claimed invention for the same reasons are set-forth above; besides Andricacos also discloses the copper in said impure copper source comprises chosen from the group of C, Cl, N, O and S (col. 8, lines 41-46).

Regarding to claim 13, Andricacos discloses a copper interconnect (fig. 6) comprising: an insulating layer that has an opening (reference numeral 1); a barrier layer (reference numeral 4) that prevents substantial diffusion of copper through to said underlying insulating layer that is deposited on said underlying insulating layer and lines said opening; an impure copper seed derived from an impure copper seed with content of impurity that Is deposited on said barrier layer and fills said opening (fig. 6); an impure copper (reference numeral 6) derived from an impure copper source with a content of impurities that fills an opening in said underlying insulating layer (6) that is

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deposited on said impure copper seed layer (5). Although, Andricacos does not explicitly teach the material composition of said seed layer is substantially the same as material composition of said impure copper fill, it would have been obvious to one having ordinary skill in the art at the time the invention was made to use the same material composition for both the impure copper seed layer and the impure copper fill, since it is going to lower the cost of making the product.

Regarding **claim 14**, Andricacos discloses all the limitations of the claimed invention; on another hand, the Applicant admits the copper in the impure copper seed layer and the electroplated copper are both derived from a source with an impurity content of not more than 1.20 % by weight and not less than or equal to 0.001% by weight are general well-known impure copper sources (present Invention's specification: pg. 5, par. 20, lines 4-9).

Regarding **claim 15**, Andricacos discloses all the limitations of the claimed invention for the same reasons are set-forth above; besides Andricacos also discloses the copper in said impure copper source comprises chosen from the group of C, Cl, N, O and S (col. 8, lines 41-46).

Response to Applicant's Amendment and Arguments

4. Applicant's arguments with respect to claims 1-5 and 13-15 have been considered but are moot in view of the new ground(s) of rejection.

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Conclusion

- 5. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a). A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.
- 6. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Tram H. Nguyen whose telephone number is (571)272-5526. The examiner can normally be reached on Monday-Friday, 8:30 AM 5:00 PM. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Minsun Harvey can be reached on (571)272-1835. The fax numbers for all communication(s) is (703)872-9306.

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Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (571)272-1625.

Tram H. Nguyen Art Unit 2818

Art Unit 2818 July 6th, 2006 DOUGLAS W. OWENS PRIMARY EXAMINER

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